

## 7<sup>th</sup> IEEE Electron Devices Technology and Manufacturing (EDTM) Conference 2023

March 7 - 10, 2023 / COEX Seoul, Korea

29B. Fabrication and Integration	
Session Date:	March 9(Thu.),2023
Session Time:	13:00-14:20
Session Room:	Room B (#307 bc)
Session Chair:	Prof. Sung Hun Jin (Incheon National University)
	Prof. Jeongkyun Roh (Pusan National University)

[29B-1] [Invited] 13:00-13:25

Integrated Light Source Technologies for Enabling Laser-Integrated Silicon Photonics Chips

Harini Raghavan, Youngmin Kim, Hyo-Jun Joo, Yongduck Jung, Yadong Wang, Kunze Lu, Manlin Luo, Dong-Ho Kang, Hao Sun and Donguk Nam

Nanyang Technological University

[29B-2] [Invited] 13:25-13:50

## **Liquid-Assistant Transfer Printing Technology**

Yue Zhang and Baoxing Xu

The University of Virginia

[29B-3] 13:50-14:05

## Pixel Design with Improved Demodulation Contrast for Indirect Time-of-Flight CMOS Image Sensor

Jaehyung Jang, Hoon-Moo Choi, Jongchae Kim, Kyungdo Kim, Hoon-Sang Oh and Chang-Rock Song

SK hynix Inc.

[29B-4] 14:05-14:20

## Silicon-Based High-Gain Photodetector with a Strong 254-nm Response for Chemical Oxygen Demand (COD) Monitoring in City Sewage Water

Xin Jin<sup>1</sup>, Haolin Zhao<sup>1</sup>, Chao Gao<sup>1</sup>, Tao Ma<sup>1</sup>, Zhou Zhou<sup>1</sup>, Xinghui Liu<sup>2</sup>, Wangchang Guo<sup>2</sup> and Kai Wang1

<sup>1</sup>Sun Yat-sen University, <sup>2</sup>Guangke Chipwey Sensing Technologies Co., Ltd.